

# MEMSWAVE 2013

## 14<sup>th</sup> International Symposium on RF-MEMS and RF-Microsystems

Potsdam, Germany – July 1-3, 2013

*Kongresshotel, Potsdam*

***Abstract submission deadline is extended to  
10<sup>th</sup> of April, 2013.***

### **CALL FOR PAPERS**

MEMSWAVE 2013 is the 14<sup>th</sup> edition of an international event to be held in Potsdam, Germany (July 1-3, 2013). The series of MEMSWAVE started in 2000 in Sinaia ROMANIA and since 2004 has been promoted by AMICOM Network of Excellence on RF-MEMS and RF-Microsystems (MST), funded by the EC in FP6. AMICOM evolved into the RF-MEMS Topical Group of the European Microwave Association, which sponsors the MEMSWAVE Symposium.

- **The RF-MST Cluster Meeting (July 1<sup>st</sup>, 2013)** co-organized with the European Commission, where the achievements of MEMS-related EU projects will be illustrated and discussed.
- **The MEMSWAVE Workshop (July 2<sup>nd</sup>-3<sup>rd</sup>, 2013)** where invited and peer reviewed papers will be presented to provide an international forum for scientists and industrialists for the exchange of information on the most recent advances and best achievements in the area of **RF-MEMS, MSTs and RF-NEMS** with emphasis on European achievements.
  - ***A special issue of International Journal of Microwave and Wireless Technologies (IJMWT) will be published with the collection of selected MEMSWAVE 2013 Symposium papers.***
  - **Increased participation is desired in the areas of Heterogeneous Integration of MEMS, 3D Integration and TSVs.**

### **IMPORTANT DEADLINES**

Abstract submission deadline

~~April 1, 2013~~ **April 10, 2013**

Notification of acceptance

~~April 15, 2013~~ **April 30, 2013**

Submission of full papers

~~May 13, 2013~~ **May 20, 2013**

[www.memswave2013.org](http://www.memswave2013.org)

**Papers are solicited in the following areas related to RF-MEMS and RF-NEMS:**

- Design and simulation tools
- Fabrication, processes and materials
- Packaging, assembling, 3D integration
- Components and circuits
- Antennas
- MEMS and IC integration
- Reliability and testing
- Application and system design

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**SUBMISSION OF SUMMARY**

The deadline for submissions is April 10 , 2013.  
The summaries should be in English, typed single  
space, and up to 2 pages, including figures and  
diagrams. The summary must begin with title,  
authors name, affiliation and full address.

To submit your summary, please follow the  
MEMSWAVE webpage:

<http://www.memswave2013.org>

**MEMSWAVE 2013 SECRETARIAT**

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